



Customer Information Notification

202204002I

Issue Date: 06/04/2022
Effective Date: 06/04/2022

Here is your personalized quality information concerning products our customers and partners purchased from Ampleon. For detailed information we invite you to view this notification online

Management Summary

New packing method added to the data sheet of released GEN11 drivers

Change Category

- Wafer Fab process, Assembly Process, Product Marking, Design, Wafer Fab materials, Assembly Materials, Electrical spec./Test coverage, Mechanical Specification, Wafer Fab location, Assembly Location, Test Location, Packing/Shipping/Labeling

Datasheet update B11G1822N60D, B11G2327N70D, B11G3338N80D

Information Notification

High volume sampling of GEN11 macro drivers is facilitated by Tape and Reel 1.5k pcs packing. To enable lower volumes orders for tier2 and distribution partners Ampleon released tape-real 0.3k pcs packing. New packing method comes as addition to the data sheet of released GEN11 drivers: B11G1822N60D, B11G2327N70D, B11G3338N80D

Why do we issue this Information Notification

To inform customers on the new minimum orderable quantity of 300 pcs for the 3 affected product types.

Identification of affected Products

Product identification does not change

Impact

Data Sheet Revision

A new datasheet will be issued

Disposition of Old Products

not applicable

Additional information

Affected products, sales history information as well as self qualification / additional documents can be accessed here: view online